<u>MOSFET</u> – N-Channel, SUPERFET[®] II, Easy-Drive

600 V, 37 A, 99 m Ω

FCH099N60E

Description

SUPERFET II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SUPERFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SUPERFET II MOSFET series.

Features

- Typ. $R_{DS(on)} = 87 \text{ m}\Omega$
- 650 V @ $T_J = 150^{\circ}C$
- Ultra Low Gate Charge (Typ. Q_g = 88 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 309 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

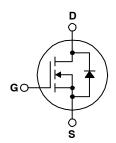
- Telecom / Sever Power Supplies
- Industrial Power Supplies



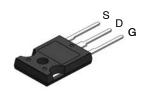
ON Semiconductor®

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V _{DS}	R _{DS(ON)} MAX	I _D MAX
600 V	99 mΩ @ 10 V	37 A

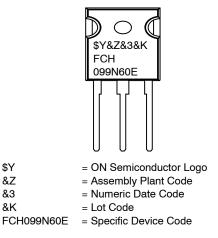


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Paramet	ter	FCH099N60E	Unit			
V _{DSS}	Drain to Source Voltage		600	V			
V _{GSS}	Gate to Source Voltage – DC		±20	V			
		– AC (f > 1 Hz)	±30				
I _D	Drain Current:	– Continuous (T _C = 25°C)	37	A			
		– Continuous (T _C = 100°C)	24				
I _{DM}	Drain Current: – Pulsed (Note 1)	DM Drain Current: - Pulsed (Note 1)	– Pulsed (Note 1)	- Pulsed (Note 1)	111	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		809	mJ			
I _{AR}	Avalanche Current (Note 1)		6.8	A			
E _{AR}	Repetitive Avalanche Energy (Note 1)		3.57	mJ			
dv/dt	MOSFET dv/dt	MOSFET dv/dt		V/ns			
	Peak Diode Recovery dv/dt (Note 3)		20				
PD	Power Dissipation	(T _C = 25°C)	357	W			
		- Derate Above 25°C	2.85	W/°C			
T _J , T _{STG}	Operating and Storage Temperature Rang	je	–55 to + 150	°C			
ΤL	Maximum Lead Temperature for Soldering	g, 1/8″ from Case for 5 Seconds	300	°C			

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 6.8 \text{ A}, R_G = 25 \Omega$, Starting $T_J = 25 \text{ °C}$. 3. $I_{SD} \le 18.5 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le 380 \text{ V}, \text{ Starting } T_J = 25 \text{ °C}.$

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH099N60E	FCH099N60E	TO-247	Tube	N/A	N/A	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH099N60E	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.35	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit				
OFF CHARA	DFF CHARACTERISTICS									
BV _{DSS}	Drain to Source Breakdown Voltage	I_D = 10 mA, V_{GS} = 0 V, T_J = 25°C	600	-	-	V				
		I_D = 10 mA, V_{GS} = 0 V, T_J = 150°C	650	-	-					
$\Delta {\sf BV}_{\sf DSS}$ / $\Delta {\sf T}_{\sf J}$	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, Referenced to 25°C	-	0.7	_	V/°C				
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ				
		V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125 $^{\circ}C$	-	2.1	-					
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	-	-	±100	nA				
ON CHARA	CTERISTICS		-	-	-	-				

Ve	GS(th)	Gate Threshold Voltage	$V_{GS}=V_{DS},I_{D}=250\;\mu A$	2.5	-	3.5	V
R _D	DS(on)	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 18.5 A	_	87	99	mΩ
ç	9 _{FS}	Forward Transconductance	V_{DS} = 20 V, I_{D} = 18.5 A	-	31.4	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	2604	3465	pF
C _{oss}	Output Capacitance		-	75	100	pF
C _{rss}	Reverse Transfer Capacitance		-	13.9	20	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	-	309	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 18.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	88	114	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	12	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	38	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.6	-	Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 18.5 \text{ A},$	-	24	58	ns
t _r	Turn-On Rise Time	V _{GS} = 10 V, R _g = 4.7 Ω (Note 4)	_	23	56	ns
t _{d(off)}	Turn-Off Delay Time		-	92	194	ns
t _f	Turn-Off Fall Time		-	22	54	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

۱ _S	Maximum Continuous Source to Drain Diode Forward Current		-	-	37	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	111	А
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 18.5 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 18.5 A,$	-	387	-	ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt = 100 A/μs	-	7.3	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

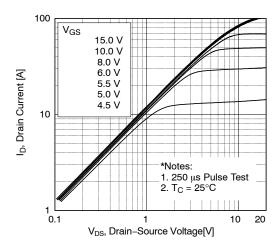
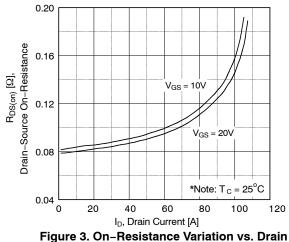


Figure 1. On–Region Characteristics



Current and Gate Voltage

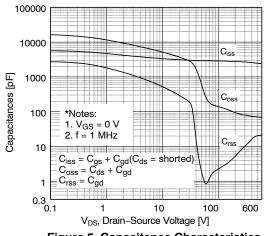


Figure 5. Capacitance Characteristics

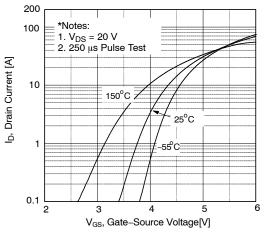


Figure 2. Transfer Characteristics

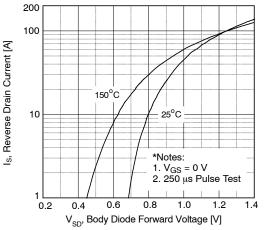


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

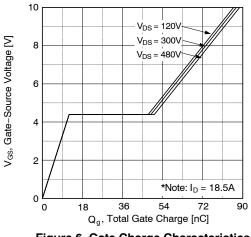


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS

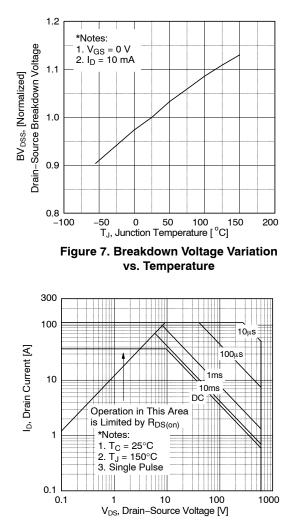


Figure 9. Maximum Safe Operating Area

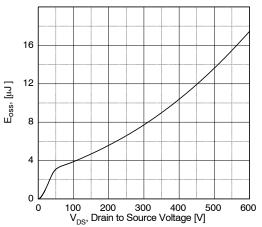
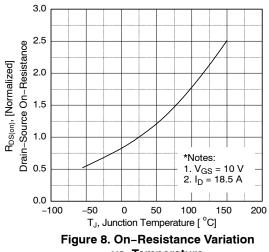
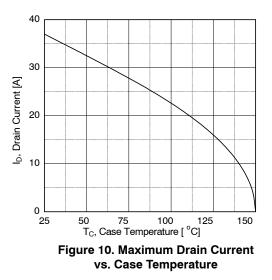


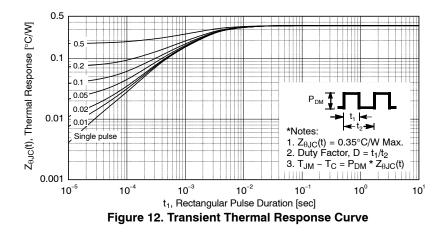
Figure 11. Eoss vs. Drain to Source Voltage

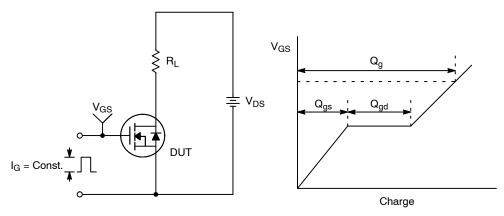


vs. Temperature



TYPICAL CHARACTERISTICS







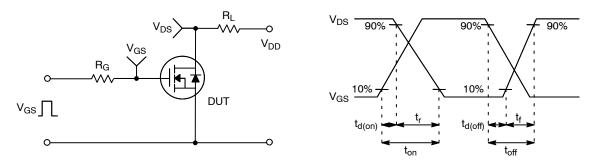


Figure 14. Resistive Switching Test Circuit & Waveforms

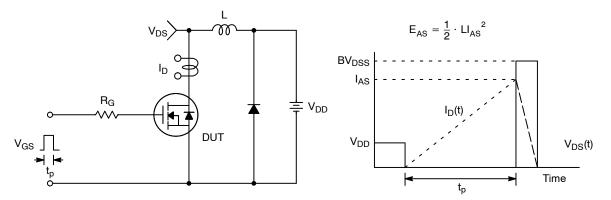


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

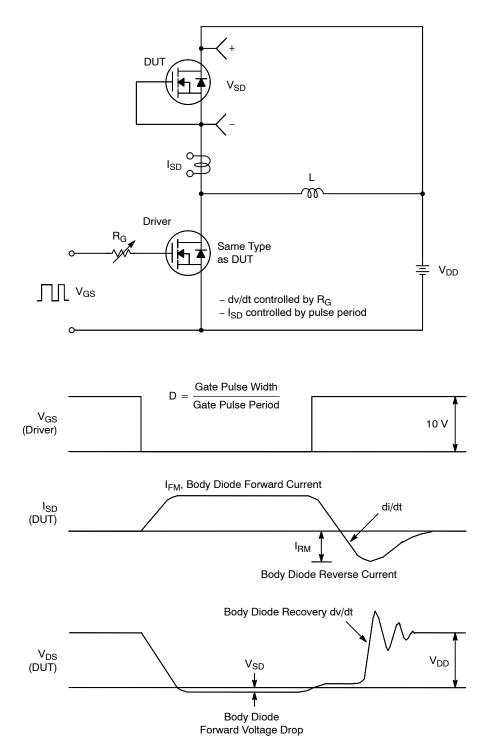


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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